PATENT ABSTRACTS OF JAPAN

(11) Publication number: 2000077720 A

(43) Date of publication of application: 14 . 03 . 00

(51) Int. CI

H01L 33/00 A1

(21) Application number: 10245250

(22) Date of filing: 31 . 08 . 98

(71) Applicant: SANYO ELECTRIC CO LTD

(72) Inventor:

KUNII HIDEO
TAKADA KIYOSHI
OCHIAI AKIRA
INOGUCHI HIROSHI
ISHIKAWA TSUTOMU
SEKIGUCHI SATOSHI
KOBORI HIROSHI

(54) OPTICAL SEMICONDUCTOR DEVICE

(57) Abstract:

PROBLEM TO BE SOLVED: To form the external shape of a light-emitting element and a photodetector as thin as possible, and to enable a miniaturization of the elements also in a module or a set with these elements incorporated therein.

SOLUTION: An optical semiconductor device is provided with semiconductor chips 23 and 24 as its light-emitting element and photodetector, and a resin sealed body 25 for sealing these chips consists of a material transparent to light. Moreover, grooves 27 are respectively formed in the region, where the light is emitted from the light-emitting element, and the region, where the light is incident in the photodetector, and reflective surfaces 26 are respectively constituted on these grooves 27. As a result, it becomes possible that the light is emitted and incident from the light-emitting element and in the photodetector via the side surface E of the sealed body 25. Moreover, as each slant surface 30 is provided on the upper parts of the reflective surfaces, the intensity of the light is strong.

